DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention **entitled**

LAYER FORMING RELIEF

the specification	on of which is attached hereto un	less the following is che	cked	·	
was filed o Application N	nas United States Applica umber and was amended of	tion Number and on(if applicable).	was filed onas PCT Ir	nternational	
I hereby state claim(s), as an	that I have reviewed and understanced by any amendment referr	and the contents of the a ed above.	bove-identified specification,	including the	
I acknowledge Regulations, §	the duty to disclose information 1.56.	which is material to pat	entability as defined in Title	37, Code of Federal	
for patent or in	foreign priority benefits under T aventor's certificate listed below ificate having a filing date before	and have also identified	below any foreign application	eign application(s) n for patent or	
				Priority Claimed	
(List prior foreig applications. See note A)	2003-28614	Japan	05/02/2003	⊠ Yes □ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
	(Number)	(Country)	(Day/Month/Year Filed)	☐ Yes ☐ No	
				☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
				☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)	, , , , , , , , , , , , , , , , , , ,	
(See note B)	See attached list for additional	orior foreign application	s		
insofar as the s in the manner information wh	the benefit under Title 35, Unite subject matter of each of the clair provided by the first paragraph on the is material to patentability as ecame available between the filiblication.	ns of this application is of Title 35, United State s defined in Title 37. Co	not disclosed in the prior Uni s Code, § 112, I acknowledg de of Federal Regulations	ted States application e the duty to disclose	
(T.:. : TIG			State	us	
(List prior U.S. Applications)			Patented Pending Abandoned		
	(Application Serial No.)	(Filing Date)			
	(Application Serial No.)	(Filing Date)	Patented Pending Abandoned		
	(Application Serial No.)	(Filing Date)	Patented Pending Abandoned		
	(Application Serial No.)	(Filing Date)	Patented Pend	ing Abandoned	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

See note C)	Full name of sole or f Inventor's signature	irst inventor (given name, family name)	Masanori AMANO Date TAN 0 2004			
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	Full name of third inv	ventor (given name, family name)				
	Inventor's signature		Date			
	Residence		Citizenship			
	Post Office Address					
	Full name of fourth in Inventor's signature	nventor (given name, family name)	Date			
	Residence		Citizenship			
	Post Office Address					
	·					
	Full name of fifth inventor (given name, family name)					
	Inventor's signature		Date			
	Residence		Citizenship			
	Post Office Address					
			4.0.0			
	Full name of sixth inventor (given name, family name) · Inventor's signature		Date			
	Residence		Citizenship			
	Post Office Address					
	1 Ost Office Address					

NOTES

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.